Customer Information Notification

202204002I : Errata Sheet Updated for RT600 with ROM.2 Errata

Issue Date: May 16, 2022 **Effective date:** May 17, 2022

Here is your personalized notification about a NXP general announcement.
For detailed information we invite you to view this notification online

Management summary
The errata sheet has been updated for the RT600 with the ROM.2 Errata.

Change Category

[ ]Wafer Fab Process	[ ]Assembly Process	[ ]Product Marking	[ ]Test Process	[ ]Design
[ ]Wafer Fab Materials	[ ]Assembly Materials	[ ]Mechanical Specification	[ ]Test Equipment	[X]Errata
[ ]Wafer Fab Location	[ ]Assembly Location	[ ]Packing/Shipping/Labeling	[ ]Test Location	[ ]Electrical spec./Test coverage
[ ]Firmware	[ ]Other			

PCN Overview
Description

The following errata sheets have been updated with the ROM.2 Errata:

RT600 errata sheet has been updated to rev 1.9, https://www.nxp.com/docs/en/errata/ES-RT600.pdf

Reason
To add the ROM.2 errata in the errata sheet.

Identification of Affected Products
Product identification does not change

Anticipated Impact on Form, Fit, Function, Reliability or Quality

See the ROM.2 errata.

Additional information

Additional documents: view online

Contact and Support

For all inquiries regarding the ePCN tool application or access issues, please contact NXP "Global Quality Support Team".

For all Quality Notification content inquiries, please contact your local NXP Sales Support team.

For specific questions on this notice or the products affected please contact our specialist directly:

Name	
	NXP Tech support

Position													

Position — NXP Technical Support

e-mail address — https://www.nxp.com/support/support:SUPPORTHOME

At NXP Semiconductors we are constantly striving to improve our product and processes to ensure they reach the highest possible Quality Standards. Customer Focus, Passion to Win.

NXP Quality Management Team.

About NXP Semiconductors

NXP Semiconductors N.V. (NASDAQ: NXPI) provides High Performance Mixed Signal and Standard Product solutions that leverage its leading RF, Analog, Power Management, Interface, Security and Digital Processing expertise. These innovations are used in a wide range of automotive, identification, wireless infrastructure, lighting, industrial, mobile, consumer and computing applications.

You have received this email because you are a designated contact or subscribed to NXP Quality Notifications. NXP shall not be held liable if this Notification is not correctly distributed within your organization.

This message has been automatically distributed. Please do not reply .

NXP Semiconductors
High Tech Campus, 5656 AG Eindhoven, The Netherlands

© 2006- 2022 NXP Semiconductors. All rights reserved.

Changed Orderable Part#	12NC	Product Type	Product Description	Package Outline	Package Description	Product Status	Customer Specific Indicator	New Orderable Part#	12NC New	Product Type New	Product Description New	Product Line	Notes
MIMXRT685SFVKB	935400264557	MIMXRT685SFVKB	i.MXRT600, 176VFBGA	(V)FBGA176 M	SOT1850-1	RFS	No					BLM1	
MIMXRT685SFFOBR	935405452518	MIMXRT685SFFOBR	RT600 249FOWLP, Sec	FOWLP249	SOT2003-1	RFS	No					BLM1	
MIMXRT685SFFOB	935405452557	MIMXRT685SFFOB	RT600 249FOWLP, Sec	FOWLP249	SOT2003-1	RFS	No					BLM1	
MIMXRT685SFAWBR	935405912019	MIMXRT685SFAWBR	RT600 114WLCSP, Sec			RFS	No					BLM1	